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**PATENT**  
Docket No.: 16869P-042900US  
Client Ref. No.: 210000749US1

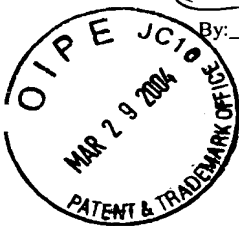
On

*March 24, 2004*

TOWNSEND and TOWNSEND and CREW LLP

By:

*Margaret K. Steple*



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of:

Takenori HIROSE, et al.

Application No.: 10/081,385

Filed: February 20, 2002

For: Film Thickness Measuring Method  
and Apparatus, and Thin Film Device  
Manufacturing Method and Manufacturing  
Apparatus Using Same

Examiner: Hwa S. Lee

Art Unit: 2877

**Response to Restriction Requirement**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Restriction Requirement mailed February 25, 2004, counsel for Assignee elects to prosecute the claims of Group I (claims 1-28) without traverse.

If the Examiner believes a telephone conference would expedite prosecution of this application, he is invited to telephone the undersigned at 650-326-2400.

Respectfully submitted,

*Robert C. Colwell*

Robert C. Colwell  
Reg. No. 27,431

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